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GUR® 4130 C

GUR®

UHMW-PE coarse particle powder grade

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Resin Identification	(PE-UHMW)		ISO 1043
Part Marking Code	>(PE-UHMW)<		ISO 11469
Average molecular weight	6.7E6 g	g/mol	Margolies' equation
Average particle size, d50	155 μ	μm	laser scattering

Rheological properties

Viscosity number	3000 cm ³ /g	ISO 307, 1628
Intrinsic viscosity	2500	ISO 307, 1628

Typical mechanical properties

Tensile modulus	640	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	19	MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	14	%	ISO 527-1/-2
Tensile stress at 50% strain	19	MPa	ISO 527-1/-2
Tensile stress at break, 50mm/min	44	MPa	ISO 527-1/-2
Nominal strain at break	440	%	ISO 527-1/-2
Elongational stress F, 150/10	0.38	MPa	ISO 21304-2
Charpy double notched impact strength, 23°C	- : :	kJ/m²	ISO 21304-2
Poisson's ratio	0.46 ^[C]		
Shore D hardness, 15s	60		ISO 48-4 / ISO 868

[C]: Calculated

Tribological properties

Wear by sandslurry method 90 (based on GUR 4120=100)

Thermal properties

Temperature of deflection under load, 1.8 MPa	38 °C	ISO 75-1/-2
Vicat softening temperature, 50°C/h 50N	80 °C	ISO 306

Electrical properties

Volume resistivity	1E12 Ohm.m	IEC 62631-3-1
Surface resistivity	1E12 Ohm	IEC 62631-3-2

Physical/Other properties

Density	930 kg/m³	ISO 1183
Bulk density	450 kg/m ³	ISO 60

Characteristics

Processing Ram Extrusion, Compression moulding

Delivery form Powder

Special characteristics High impact or impact modified, Hydrolysis resistant, Low wear / Low friction,

Chemical resistant

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